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(12) **United States Design Patent**  
**Chen et al.**

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(54) **LIGHT EMITTING DIODE**

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(\*\*) Term: **14 Years**

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(51) **LOC (9) Cl.** ..... **13-03**

(52) **U.S. Cl.** ..... **D13/180**

(58) **Field of Classification Search** ..... D13/180;  
257/79, 80, 81, 88, 89, 95, 98, 99, 100, E33.058;  
313/483, 498, 500; 362/555, 800

See application file for complete search history.

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(57) **CLAIM**

The ornamental design for a light emitting diode, as shown and described.

**DESCRIPTION**

FIG. 1 is a perspective view of a light emitting diode showing the claimed design;

FIG. 2 is a front elevational view thereof;

FIG. 3 is a rear side elevational view thereof;

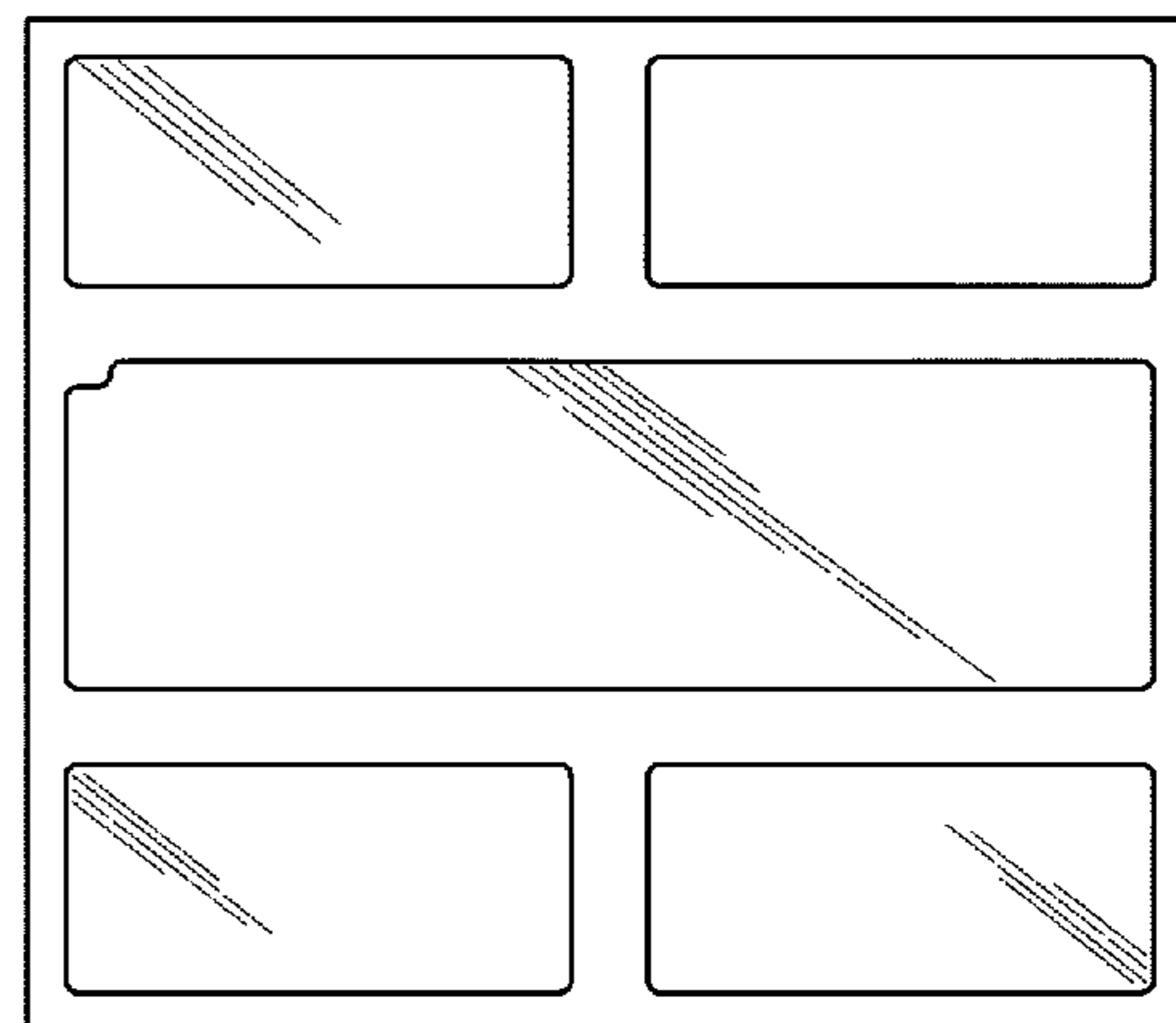
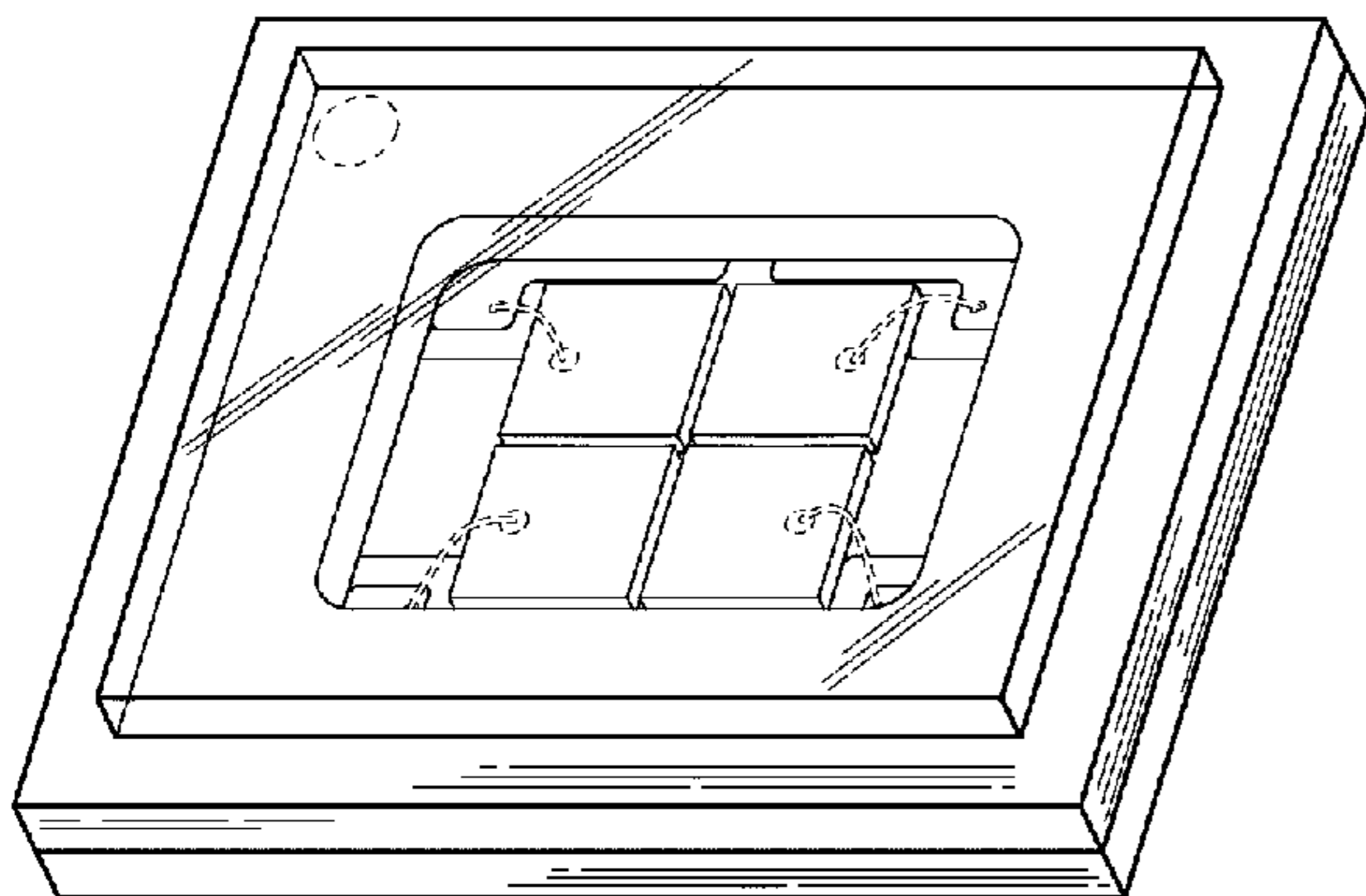
FIG. 4 is a right side elevational view thereof; a left side elevational view being a mirror image of FIG. 4;

FIG. 5 is a bottom plan view thereof; a top plan view being a mirror image of FIG. 5; and,

FIG. 6 is a cross-sectional view along Line 6-6 of FIG. 2.

The window cover of the design is made of light transmissible material. The broken lines are directed to environment and are for illustrative purpose only; the broken lines form no part of the claimed design.

**1 Claim, 4 Drawing Sheets**



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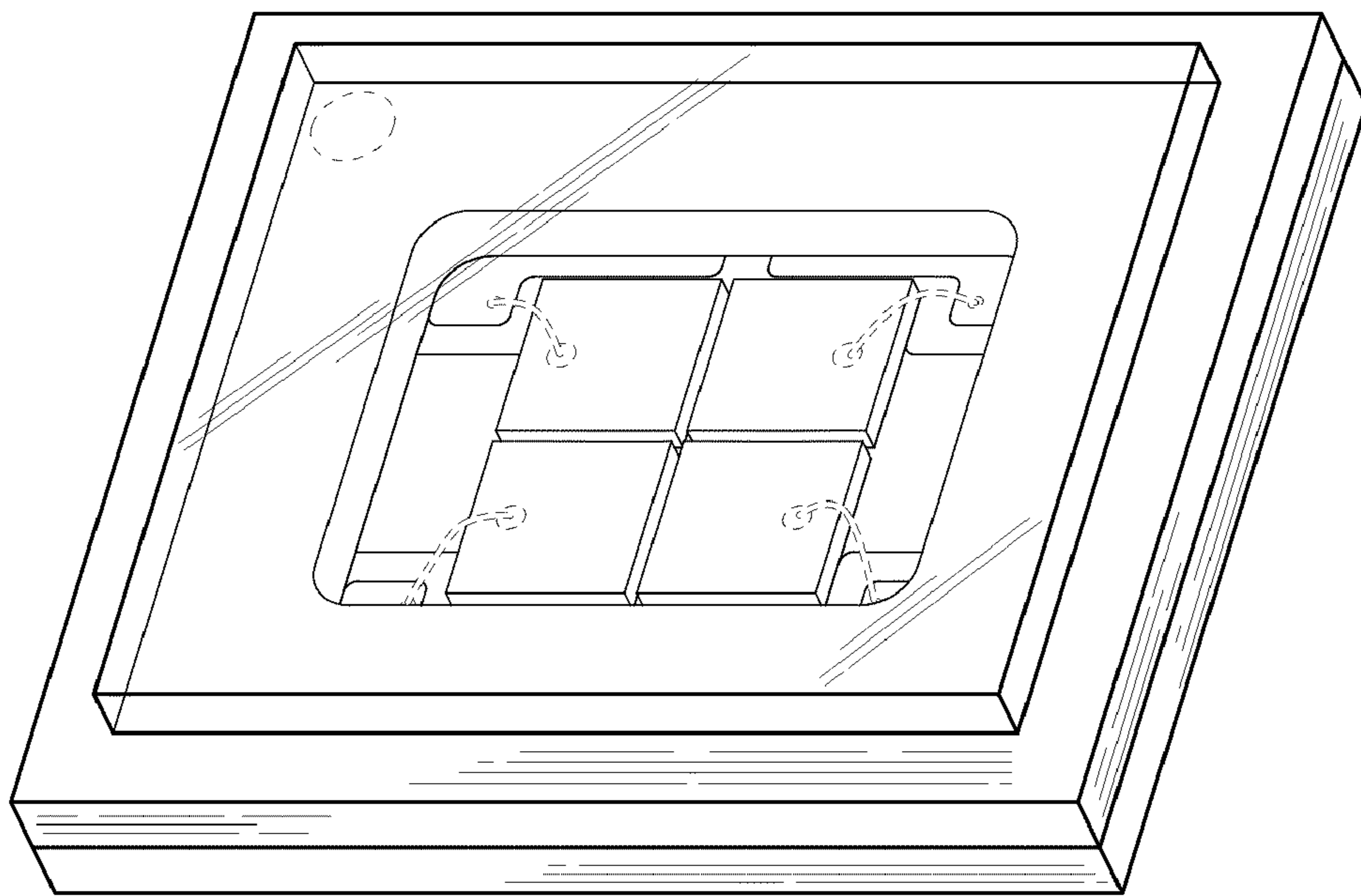


FIG. 1

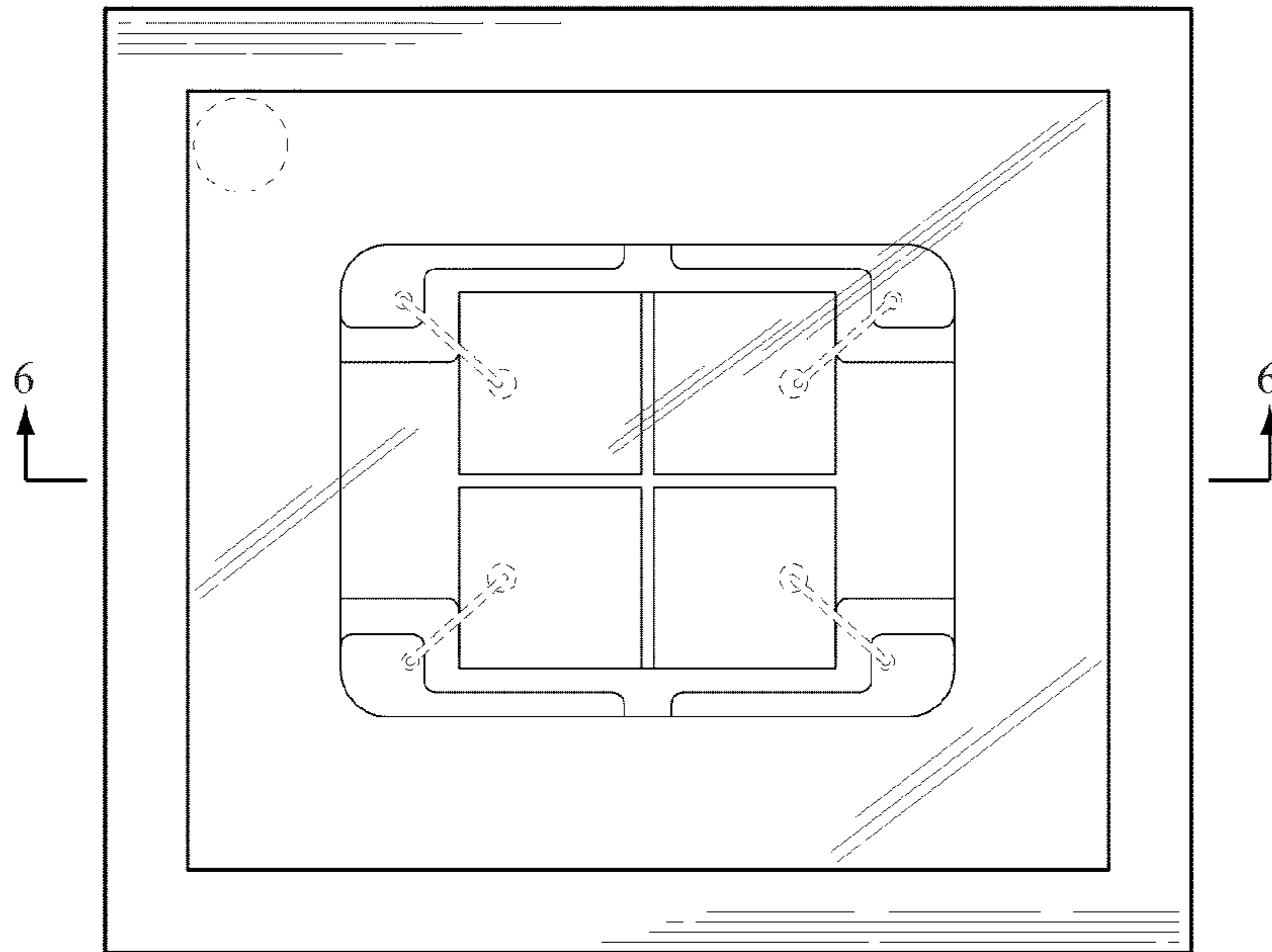


FIG. 2

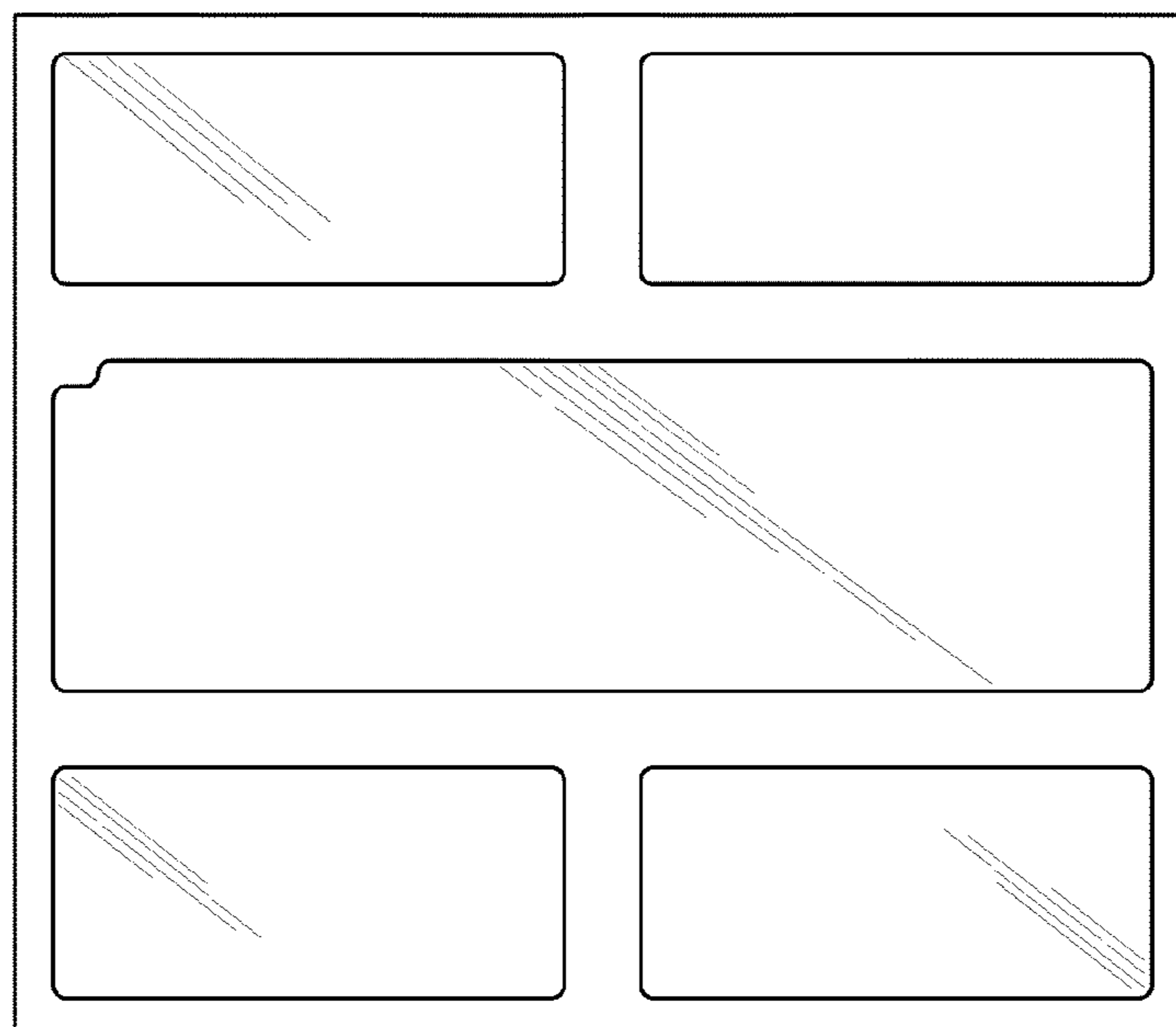


FIG. 3

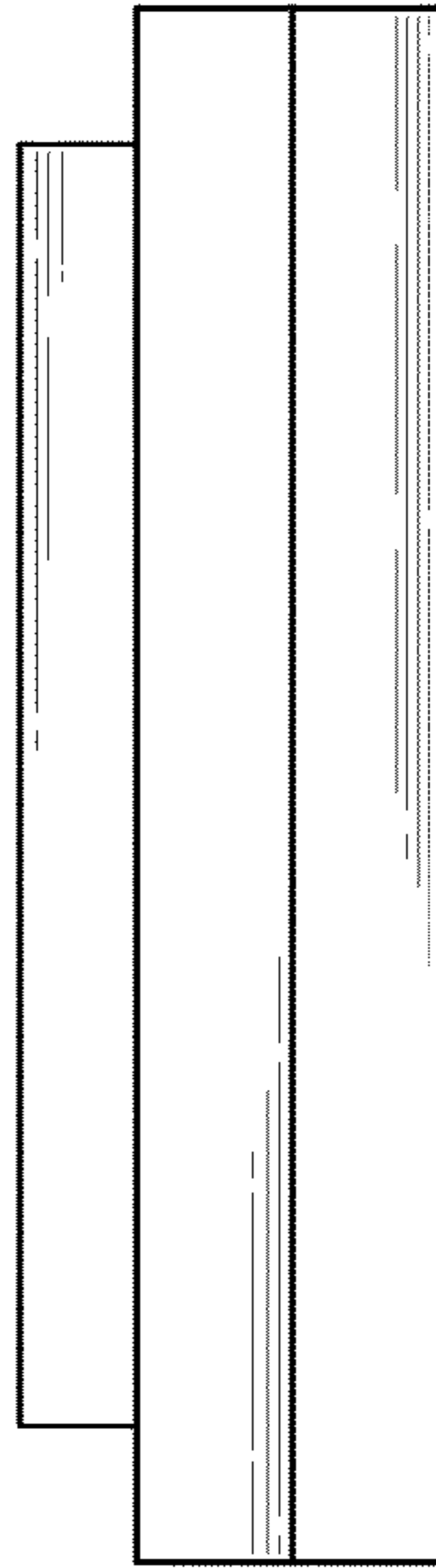


FIG. 4

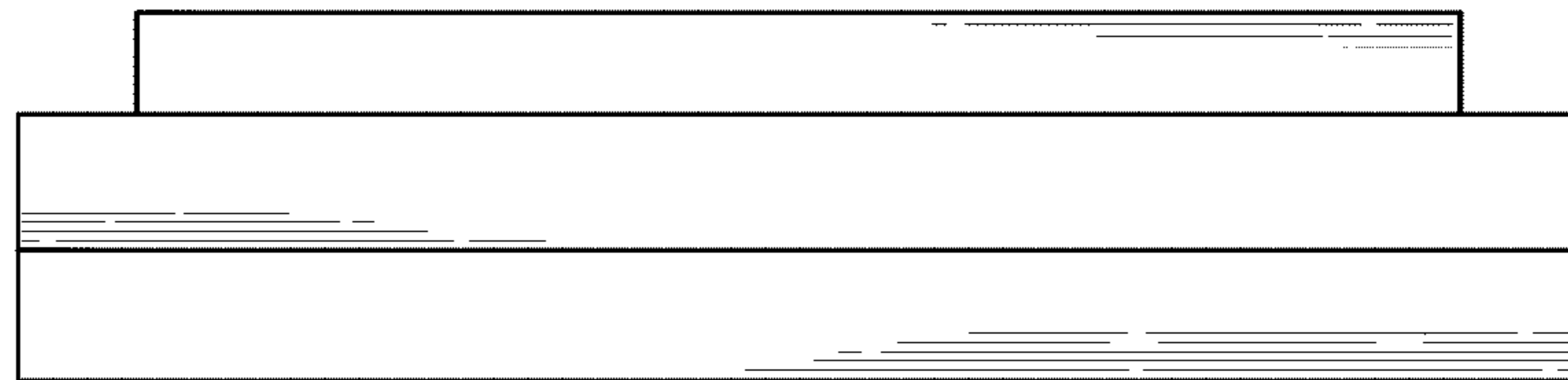


FIG. 5

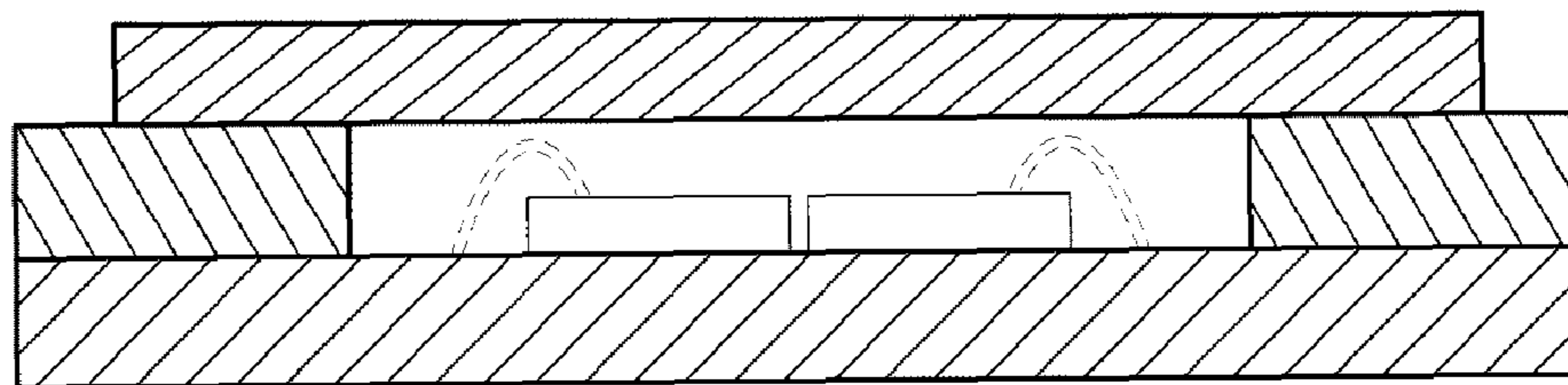


FIG.6